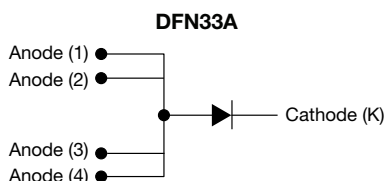


## Surface-Mount Standard Rectifier



### LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS                |                     |
|--|---------------------|
| $I_{F(AV)}$                            | 6 A                 |
| $V_{RRM}$                              | 200 V, 400 V, 600 V |
| $I_{FSM}$                              | 80 A                |
| $V_F$ at $I_F = 6$ A ( $T_J = 125$ °C) | 0.88 V              |
| $T_J$ max.                             | 175 °C              |
| Package                                | DFN33A              |
| Circuit configuration                  | Single              |

### FEATURES

- Low-profile package  
- typical height of 0.88 mm
- Leadless DFN package with side-wettable flanks suitable for customer AOI (Automatic Optical Inspection)
- Ideal for automated replacement
- Oxide planar chip junction
- Low forward voltage drop
- Typical IR less than 0.1  $\mu$ A
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available  
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### TYPICAL APPLICATIONS

General purpose, power line polarity protection and rail-to-rail protection in consumer, industrial, and automotive applications.

### MECHANICAL DATA

**Case:** DFN33A

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

| MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)                   |                                   |             |         |         |      |
|---|-----------------------------------|-------------|---------|---------|------|
| PARAMETER   | SYMBOL                            | SE60N3D     | SE60N3G | SE60N3J | UNIT |
| Device marking code   |                                   | 6D          | 6G      | 6J      |      |
| Maximum repetitive peak reverse voltage   | V <sub>RRM</sub>                  | 200         | 400     | 600     | V    |
| Maximum average forward rectified current (fig.1)                                 | I <sub>F(AV)</sub> <sup>(1)</sup> | 6           |         |         | A    |
|   | I <sub>F(AV)</sub> <sup>(2)</sup> | 1.88        |         |         |      |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I <sub>FSM</sub>                  | 80          |         |         | A    |
| Operating junction temperature range  | T <sub>J</sub> <sup>(3)</sup>     | -55 to +175 |         |         | °C   |
| Storage temperature range   | T <sub>STG</sub>                  | -55 to +175 |         |         |      |

#### Notes

(1) With infinite heatsink

(2) Free air, mounted on recommended copper pad area

(3) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$



| ELECTRICAL CHARACTERISTICS (T <sub>J</sub> = 25 °C unless otherwise noted) |                      |                         |                               |      |      |      |
|--|----------------------|-------------------------|-------------------------------|------|------|------|
| PARAMETER  | TEST CONDITIONS      |                         | SYMBOL                        | TYP. | MAX. | UNIT |
| Instantaneous forward voltage  | I <sub>F</sub> = 3 A | T <sub>J</sub> = 25 °C  | V <sub>F</sub> <sup>(1)</sup> | 0.91 | -    | V    |
|  | I <sub>F</sub> = 6 A |                         |                               | 0.98 | 1.05 |      |
|  | I <sub>F</sub> = 3 A | T <sub>J</sub> = 125 °C |                               | 0.80 | -    |      |
|  | I <sub>F</sub> = 6 A |                         |                               | 0.88 | 0.98 |      |
| Reverse current  | Rated V <sub>R</sub> | T <sub>J</sub> = 25 °C  | I <sub>R</sub> <sup>(2)</sup> | -    | 10   | μA   |
|  |                      | T <sub>J</sub> = 125 °C |                               | 18   | 100  |      |
| Typical junction capacitance   | 4.0 V, 1 MHz         |                         | C <sub>J</sub>                | 40   | -    | pF   |

**Notes**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle(2) Pulse test: pulse width  $\leq 5\text{ ms}$ 

| THERMAL CHARACTERISTICS ( $T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise specified) |                          |      |      |                      |
|--|--------------------------|------|------|----------------------|
| PARAMETER  | SYMBOL                   | TYP. | MAX. | UNIT                 |
| Thermal resistance   | $R_{\theta JA}^{(1)(2)}$ | 122  | 153  | $^{\circ}\text{C/W}$ |
|  | $R_{\theta JM}^{(3)}$    | 2.9  | 3.6  |                      |

**Notes**(1) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ (2) Thermal resistance junction-to-ambient to follow JEDEC<sup>®</sup> 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint

(3) Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

| IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS<br>( $T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted) |  |  |        |       |                   |
|--|--|--|--------|-------|-------------------|
| STANDARD   | TEST TYPE  | TEST CONDITIONS                                | SYMBOL | CLASS | VALUE             |
| AEC-Q101-001   | Human body model (contact mode)                      | $C = 100\text{ pF}$ , $R = 1.5\text{ k}\Omega$ | $V_C$  | H3B   | $> 8\text{ kV}$   |
| AEC-Q101-005   | Charge device mode                                   | Refer to AEC-Q101-005                          |        | C3    | $> 1000\text{ V}$ |
| JESD22-A114  | Human body model (contact mode)                      | $C = 100\text{ pF}$ , $R = 1.5\text{ k}\Omega$ |        | 3B    | $> 8\text{ kV}$   |
| IEC 61000-4-2 <sup>(2)</sup>   | Human body model (contact mode)                      | $C = 150\text{ pF}$ , $R = 330\text{ }\Omega$  |        | 4     | $> 8\text{ kV}$   |
|  | Human body model (air-discharge mode) <sup>(1)</sup> | $C = 150\text{ pF}$ , $R = 330\text{ }\Omega$  |        | 4     | $> 15\text{ kV}$  |

**Notes**(1) Immunity to IEC 61000-4-2 air discharge mode has a typical performance  $> 30\text{ kV}$ 

(2) System ESD standard

**ORDERING INFORMATION TABLE**

|             |   |   |    |    |   |   |    |
|-------------|---|---|----|----|---|---|----|
| Device code | S | E   | 60 | N3 | J | H | M3 |
|             | ① | ②   | ③  | ④  | ⑤ | ⑥ | ⑦  |
| ①           | - | Vishay standard recovery product  |    |    |   |   |    |
| ②           | - | Oxide planar chip technology  |    |    |   |   |    |
| ③           | - | Current rating (60 = 6 A)   |    |    |   |   |    |
| ④           | - | Package type (N3 = DFN33A package)  |    |    |   |   |    |
| ⑤           | - | Voltage rating (D = 200 V, G = 400 V, J = 600 V)  |    |    |   |   |    |
| ⑥           | - | Quality grade (H = AEC-Q101 qualified, otherwise = industry grade)                                    |    |    |   |   |    |
| ⑦           | - | Material / environmental category (M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free) |    |    |   |   |    |



## ORDERING INFORMATION (Example)

| PREFERRED P/N               | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
|-----------------------------|-----------------|------------------------|---------------|------------------------------------|
| SE60N3J-M3/I                | 0.031           | I                      | 6000          | 13" diameter plastic tape and reel |
| SE60N3JHM3/I <sup>(1)</sup> | 0.031           | I                      | 6000          | 13" diameter plastic tape and reel |

### Note

<sup>(1)</sup> AEC-Q101 qualified

## RATINGS AND CHARACTERISTICS CURVES ( $T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

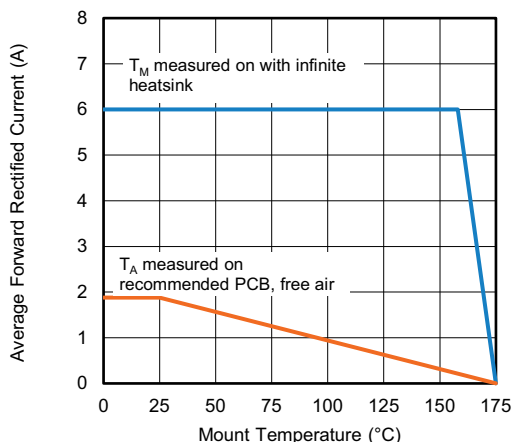


Fig. 1 - Maximum Forward Current Derating Curve

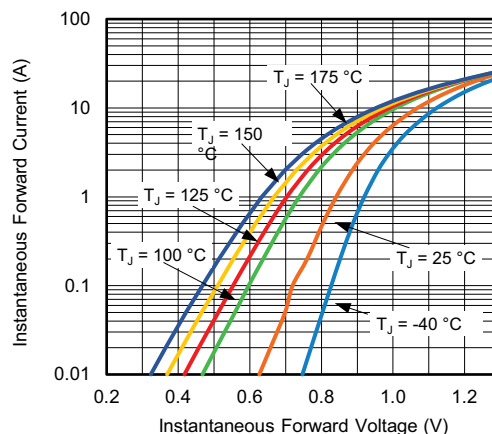


Fig. 3 - Typical Instantaneous Forward Characteristics

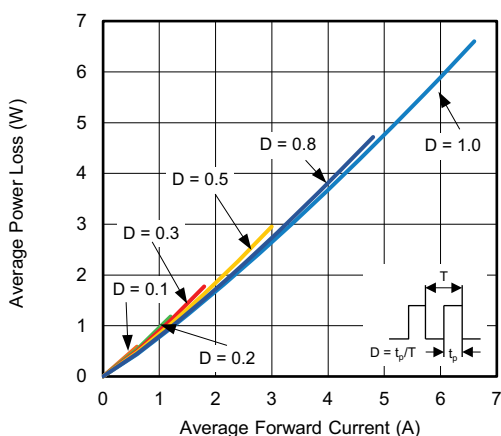


Fig. 2 - Forward Power Loss Characteristics

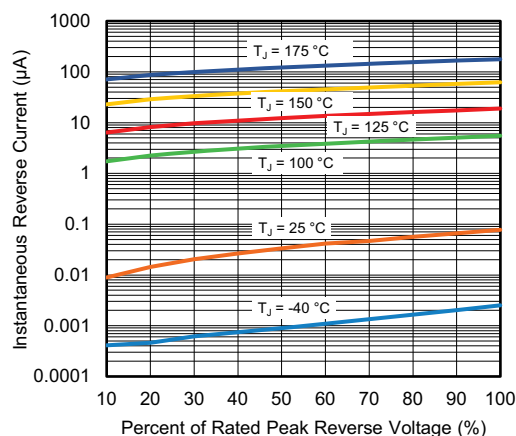
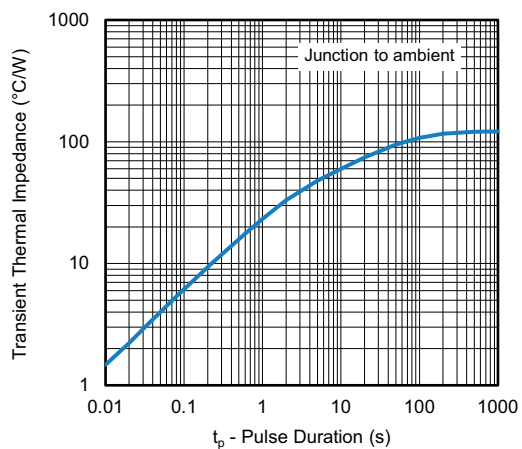
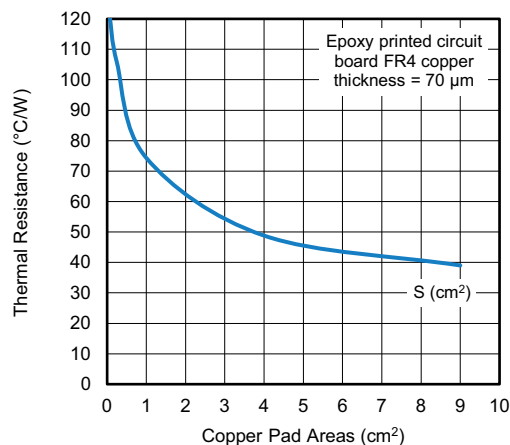
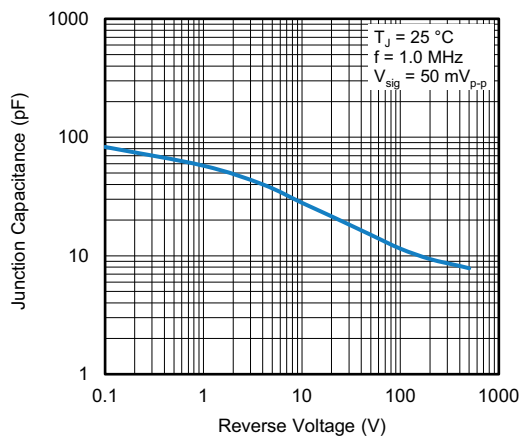


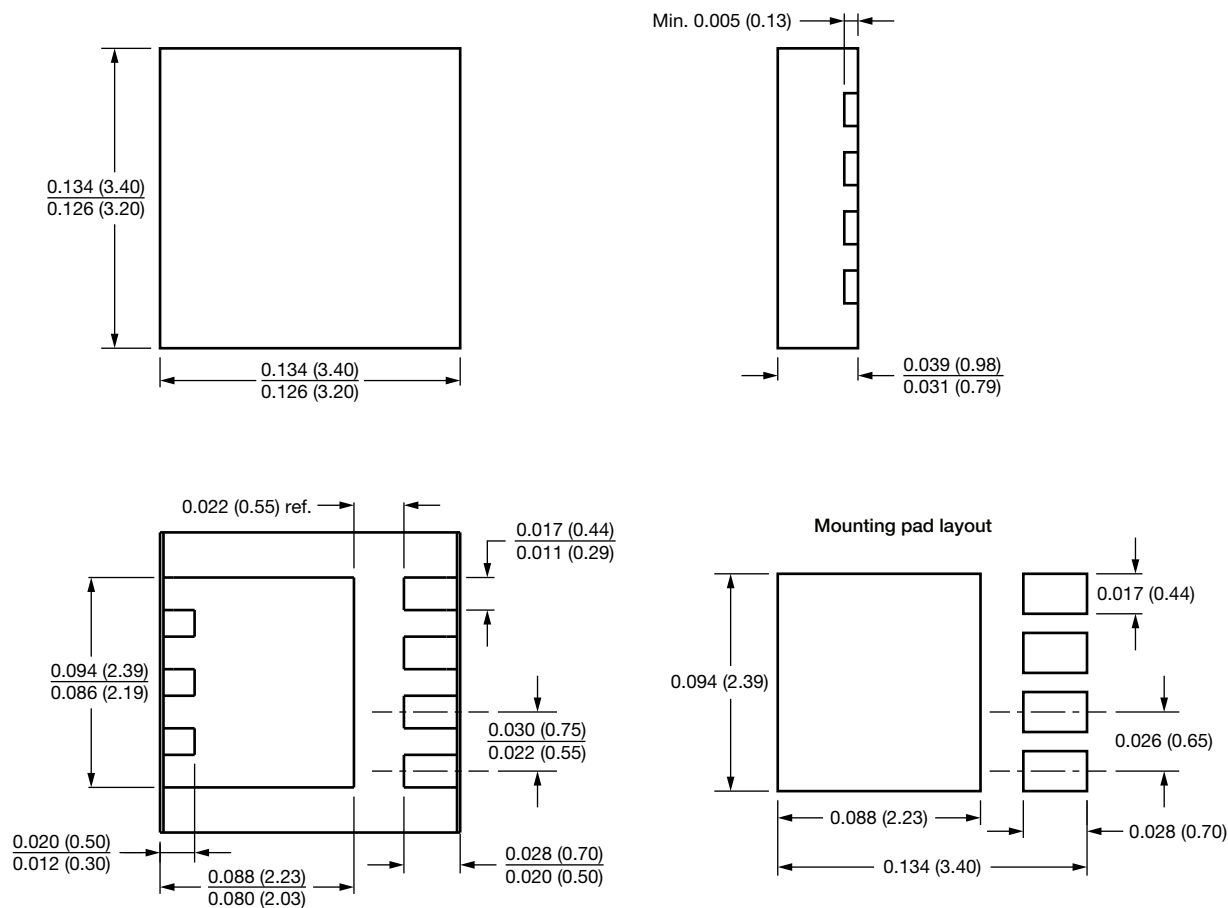
Fig. 4 - Typical Reverse Leakage Characteristics





**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

**DFN33A**





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